Product data sheet

1. General description

The 74LVC1G125-Q100 is a single buffer/line driver with 3-state output. Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V environments. Schmitt-trigger action at all inputs makes the circuit tolerant of slower input rise and fall times. This device is fully specified for partial power down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing the potentially damaging backflow current through the device when it is powered down.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide supply voltage range from 1.65 V to 5.5 V
- · Overvoltage tolerant inputs to 5.5 V
- High noise immunity
- CMOS low power consumption
- I_{OFF} circuitry provides partial Power-down mode operation
- ±24 mA output drive (V_{CC} = 3.0 V)
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Complies with JEDEC standards:
 - JESD8-7 (1.65 V to 1.95 V)
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8C (2.7 V to 3.6 V)
 - JESD36 (4.5 V to 5.5 V)
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Multiple package options



3. Ordering information

Table 1. Ordering information

Type number	Package					
	Temperature range	Name	Description	Version		
74LVC1G125GW-Q100	-40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1		
74LVC1G125GV-Q100	-40 °C to +125 °C	SC-74A	plastic surface-mounted package; 5 leads	SOT753		
74LVC1G125GM-Q100	-40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1.45 × 0.5 mm	SOT886		
74LVC1G125GZ-Q100	-40 °C to +125 °C	XSON5	plastic thermal enhanced extremely thin small outline package with side-wettable flanks (SWF); no leads; 5 terminals; body 1.1 × 0.85 × 0.5 mm	SOT8065-1		

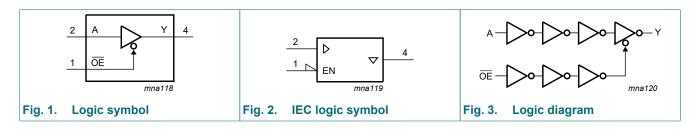
4. Marking

Table 2. Marking

Type number	Marking code[1]
74LVC1G125GW-Q100	VM
74LVC1G125GV-Q100	V25
74LVC1G125GM-Q100	VM
74LVC1G125GZ-Q100	VM

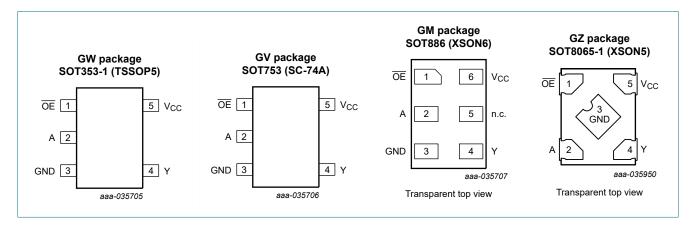
[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram



6. Pinning information

6.1. Pinning



6.2. Pin description

Table 3. Pin description

Symbol	Pin	Description	
	TSSOP5, SC-74A and XSO XSON5		
ŌĒ	1	1	output enable input
A	2	2	data input
GND	3	3	ground (0 V)
Υ	4	4	data output
n.c.	-	5	not connected
V _{CC}	5	6	supply voltage

7. Functional description

Table 4. Function table

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = don't \ care; \ Z = high-impedance \ OFF-state.$

Input A		Output
ŌE	A	Υ
L	L	L
L	Н	Н
Н	X	Z

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
VI	input voltage	[1]	-0.5	+6.5	V
I _{OK}	output clamping current	$V_O > V_{CC}$ or $V_O < 0$ V	-	±50	mA
Vo	output voltage	Active mode [1]	-0.5	V _{CC} + 0.5	V
		Power-down mode; V _{CC} = 0 V [1]	-0.5	+6.5	V
Io	output current	$V_O = 0 \text{ V to } V_{CC}$	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mΑ
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$ [2]	-	250	mW
T _{stg}	storage temperature		-65	+150	°C

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

9. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.65	-	5.5	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	Active mode	0	-	V _{CC}	V
		Power-down mode; V _{CC} = 0 V	0	-	5.5	V
T _{amb}	ambient temperature		-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 1.65 V to 2.7 V	-	-	20	ns/V
		V _{CC} = 2.7 V to 5.5 V	-	-	10	ns/V

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^[2] For SOT353-1 (TSSOP5) package: P_{tot} derates linearly with 3.3 mW/K above 74 °C. For SOT753 (SC-74A) package: P_{tot} derates linearly with 3.8 mW/K above 85 °C. For SOT886 (XSON6) package: P_{tot} derates linearly with 3.3 mW/K above 74 °C. For SOT8065-1 (XSON5) package: P_{tot} derates linearly with 3.2 mW/K above 72 °C.

10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ [1]	Max	Unit
T _{amb} = -	40 °C to +85 °C			•		1
V _{IH}	HIGH-level input voltage	V _{CC} = 1.65 V to 1.95 V	0.65 × V _{CC}	-	-	V
		V _{CC} = 2.3 V to 2.7 V	1.7	-	-	V
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	V
		V _{CC} = 4.5 V to 5.5 V	0.7 × V _{CC}	-	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	0.35 × V _{CC}	V
		V _{CC} = 2.3 V to 2.7 V	-	-	0.7	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	V
		V _{CC} = 4.5 V to 5.5 V	-	-	0.3 × V _{CC}	V
V _{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		V _{CC} = 1.65 V to 5.5 V; I _O = 100 μA	-	-	0.1	V
		V _{CC} = 1.65 V; I _O = 4 mA	-	-	0.45	V
		V _{CC} = 2.3 V; I _O = 8 mA	-	-	0.3	V
		V _{CC} = 2.7 V; I _O = 12 mA	-	-	0.4	V
		V _{CC} = 3.0 V; I _O = 24 mA	-	-	0.55	V
		V _{CC} = 4.5 V; I _O = 32 mA	-	-	0.55	V
V _{OH}	HIGH-level output voltage	$V_{I} = V_{IH}$ or V_{IL}				
		V _{CC} = 1.65 V to 5.5 V; I _O = -100 μA	V _{CC} - 0.1	-	-	V
		V _{CC} = 1.65 V; I _O = -4 mA	1.2	-	-	V
		V _{CC} = 2.3 V; I _O = -8 mA	1.9	-	-	V
		V _{CC} = 2.7 V; I _O = -12 mA	2.2	-	-	V
		V _{CC} = 3.0 V; I _O = -24 mA	2.3	-	-	V
		V _{CC} = 4.5 V; I _O = -32 mA	3.8	-	-	V
I _I	input leakage current	V _{CC} = 0 V to 5.5 V; V _I = 5.5 V or GND	-	±0.1	±1	μΑ
l _{OZ}	OFF-state output current	$V_{CC} = 3.6 \text{ V}; V_I = V_{IH} \text{ or } V_{IL};$ $V_O = 5.5 \text{ V or GND}$	-	±0.1	±2	μΑ
I _{OFF}	power-off leakage current	$V_{CC} = 0 \text{ V}; V_{I} \text{ or } V_{O} = 5.5 \text{ V}$	-	±0.1	±2	μΑ
I _{CC}	supply current			0.1	4	μΑ
ΔI _{CC}	additional supply current			500	μΑ	
Cı	input capacitance		-	5	-	pF

Symbol	Parameter	Conditions	Min	Typ [1]	Max	Unit
T _{amb} = -	40 °C to +125 °C		1			
V _{IH} HIGH-level input voltage		V _{CC} = 1.65 V to 1.95 V	0.65 × V _{CC}	-	-	V
		V _{CC} = 2.3 V to 2.7 V	1.7	-	-	V
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	V
		V _{CC} = 4.5 V to 5.5 V	0.7 × V _{CC}	-	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	0.35 × V _{CC}	V
		V _{CC} = 2.3 V to 2.7 V	-	-	0.7	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	V
		V _{CC} = 4.5 V to 5.5 V	-	-	0.3 × V _{CC}	V
V _{OL}	LOW-level output voltage	V _I = V _{IH} or V _{IL}				
		V _{CC} = 1.65 V to 5.5 V; I _O = 100 μA	-	-	0.1	V
		V _{CC} = 1.65 V; I _O = 4 mA	-	-	0.70	V
		V _{CC} = 2.3 V; I _O = 8 mA	-	-	0.45	V
		V _{CC} = 2.7 V; I _O = 12 mA	-	-	0.60	V
		V _{CC} = 3.0 V; I _O = 24 mA	-	-	0.80	V
		V _{CC} = 4.5 V; I _O = 32 mA	-	-	0.80	V
V _{OH}	HIGH-level output voltage	V _I = V _{IH} or V _{IL}				
		V_{CC} = 1.65 V to 5.5 V; I_{O} = -100 μ A	V _{CC} - 0.1	-	-	V
		V _{CC} = 1.65 V; I _O = -4 mA	0.95	-	-	V
		$V_{CC} = 2.3 \text{ V; I}_{O} = -8 \text{ mA}$	1.7	-	-	V
		V _{CC} = 2.7 V; I _O = -12 mA	1.9	-	-	V
		V _{CC} = 3.0 V; I _O = -24 mA	2.0	-	-	V
		V _{CC} = 4.5 V; I _O = -32 mA	3.4	-	-	V
l _l	input leakage current	V _{CC} = 0 V to 5.5 V; V _I = 5.5 V or GND	-	-	±1	μΑ
I _{OZ}	OFF-state output current	$V_{CC} = 3.6 \text{ V}; V_I = V_{IH} \text{ or } V_{IL};$ $V_O = 5.5 \text{ V or GND}$	-	-	±2	μΑ
I _{OFF}	power-off leakage current	V _{CC} = 0 V; V _I or V _O = 5.5 V	-	-	±2	μΑ
I _{CC}	supply current	$V_I = 5.5 \text{ V or GND}; V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}; I_O = 0 \text{ A}$	-	-	4	μΑ
ΔI _{CC}	additional supply current	per pin; V _{CC} = 2.3 V to 5.5 V; V _I = V _{CC} - 0.6 V; I _O = 0 A	-	-	500	μΑ

^[1] All typical values are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.

11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Fig. 6.

Symbol	Parameter	Conditions	-40	°C to +85	°C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation delay	A to Y; see <u>Fig. 4</u> [2]						
		V _{CC} = 1.65 V to 1.95 V	1.0	3.3	8.0	1.0	10.5	ns
		V _{CC} = 2.3 V to 2.7 V	0.5	2.2	5.5	0.5	7	ns
		V _{CC} = 2.7 V	0.5	2.5	5.5	0.5	7	ns
		V _{CC} = 3.0 V to 3.6 V	0.5	2.1	4.5	0.5	6	ns
		V _{CC} = 4.5 V to 5.5 V	0.5	1.7	4.0	0.5	5.5	ns
t _{en}	enable time	OE to Y; see Fig. 5 [3]						
		V _{CC} = 1.65 V to 1.95 V	1.0	4.1	9.4	1.0	12	ns
		V _{CC} = 2.3 V to 2.7 V	0.5	2.8	6.6	0.5	8.5	ns
		V _{CC} = 2.7 V	0.5	3.3	6.6	0.5	8.5	ns
		V _{CC} = 3.0 V to 3.6 V	0.5	2.4	5.3	0.5	7	ns
		V _{CC} = 4.5 V to 5.5 V	0.5	2.1	5.0	0.5	6.5	ns
t _{dis}	disable time	OE to Y; see Fig. 5 [4]						
		V _{CC} = 1.65 V to 1.95 V	1.0	4.3	9.2	1.0	12	ns
		V _{CC} = 2.3 V to 2.7 V	0.5	2.7	5.0	0.5	6.5	ns
		V _{CC} = 2.7 V	0.5	3.0	5.0	0.5	6.5	ns
		V _{CC} = 3.0 V to 3.6 V	0.5	3.1	5.0	0.5	6.5	ns
		V _{CC} = 4.5 V to 5.5 V	0.5	2.2	4.2	0.5	5.5	ns
C _{PD}	power dissipation	per buffer; $V_I = GND$ to V_{CC} [5]						
	capacitance	output enabled	-	25	-	-	-	pF
		output disabled	-	6	-	-	-	pF

^[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.8 V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively.

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

f_o = output frequency in MHz;

C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_0) = \text{sum of outputs.}$

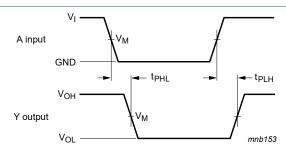
^[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

^[3] t_{en} is the same as t_{PZH} and t_{PZL} .

^[4] t_{dis} is the same as t_{PLZ} and t_{PHZ} .

^[5] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

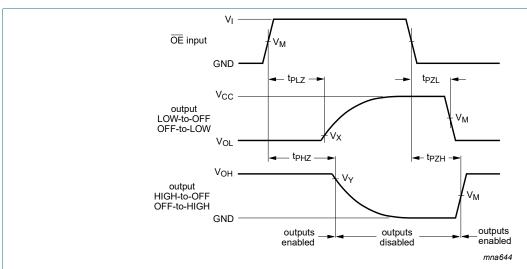
11.1. Waveforms and test circuit



Measurement points are given in Table 9.

V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig. 4. Input A to output Y propagation delay times



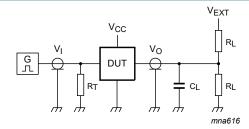
Measurement points are given in <u>Table 9</u>.

 V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig. 5. 3-state enable and disable times

Table 9. Measurement points

Supply voltage	Input	Output		
V _{CC}	V _M	V _M	V _X	V _Y
1.65 V to 1.95 V	0.5 × V _{CC}	0.5 × V _{CC}	V _{OL} + 0.15 V	V _{OH} - 0.15 V
2.3 V to 2.7 V	0.5 × V _{CC}	0.5 × V _{CC}	V _{OL} + 0.15 V	V _{OH} - 0.15 V
2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} - 0.3 V
3.0 V to 3.6 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} - 0.3 V
4.5 V to 5.5 V	0.5 × V _{CC}	0.5 × V _{CC}	V _{OL} + 0.3 V	V _{OH} - 0.3 V



Test data is given in Table 10.

Definitions for test circuit:

R_L = Load resistance;

 C_L = Load capacitance including jig and probe capacitance;

R_T = Termination resistance should be equal to the output impedance Z_o of the pulse generator;

 V_{EXT} = External voltage for measuring switching times.

Fig. 6. Test circuit for measuring switching times

Table 10. Test data

Supply voltage	Input		Load		V _{EXT}		
V _{CC}	VI	t _r , t _f	CL	R _L	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
1.65 V to 1.95 V	V _{CC}	≤ 2.0 ns	30 pF	1 kΩ	open	GND	2 × V _{CC}
2.3 V to 2.7 V	V _{CC}	≤ 2.0 ns	30 pF	500 Ω	open	GND	2 × V _{CC}
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	GND	6 V
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	GND	6 V
4.5 V to 5.5 V	V _{CC}	≤ 2.5 ns	50 pF	500 Ω	open	GND	2 × V _{CC}

12. Package outline

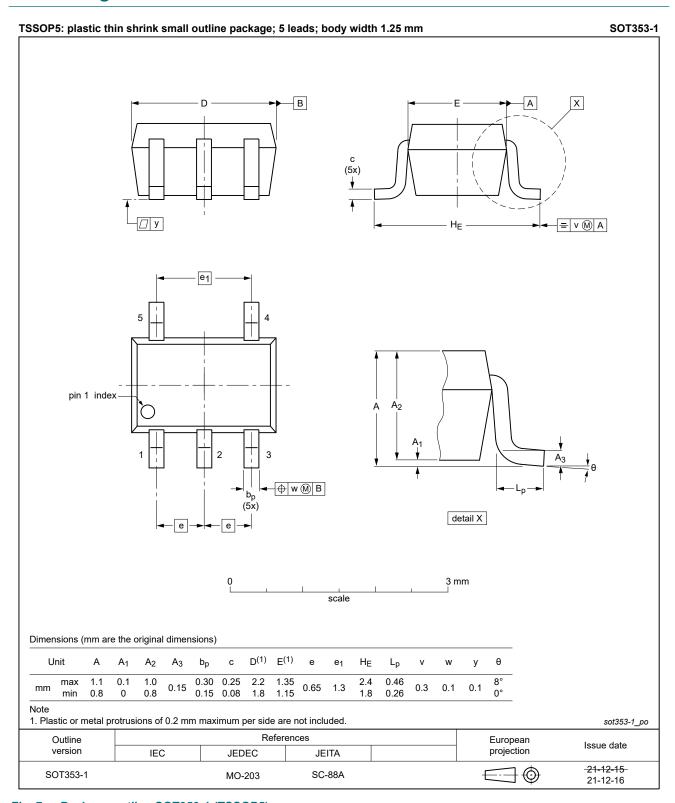
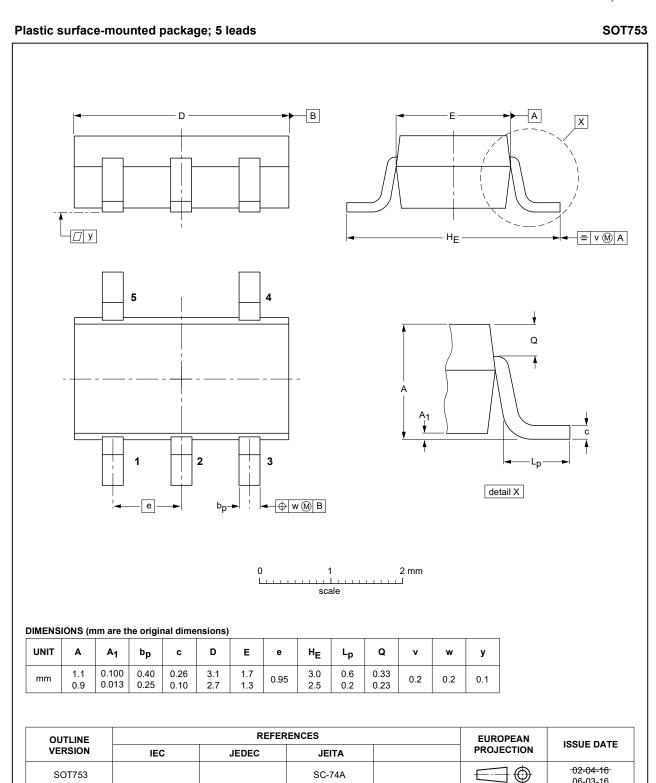


Fig. 7. Package outline SOT353-1 (TSSOP5)



Package outline SOT753 (SC-74A)

SOT753

SC-74A

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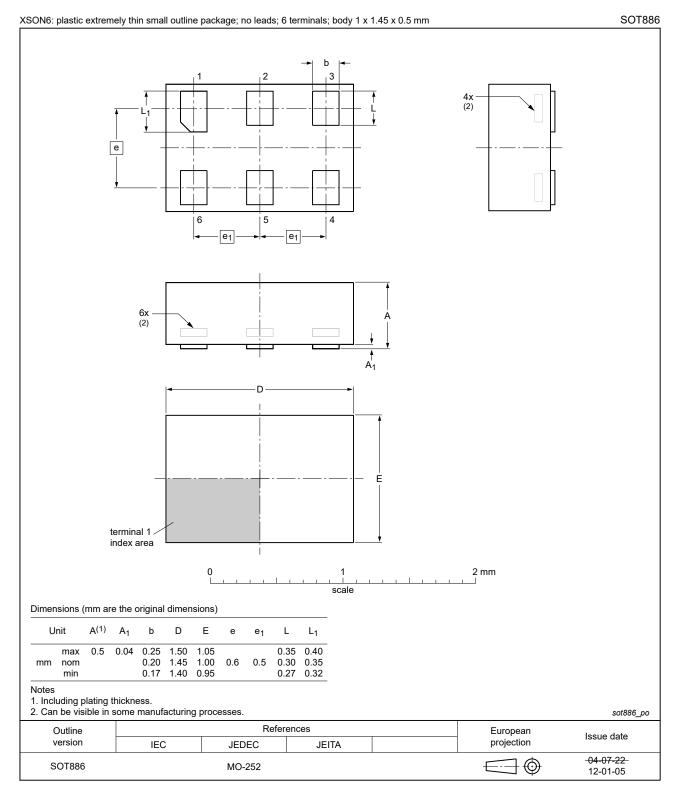


Fig. 9. Package outline SOT886 (XSON6)

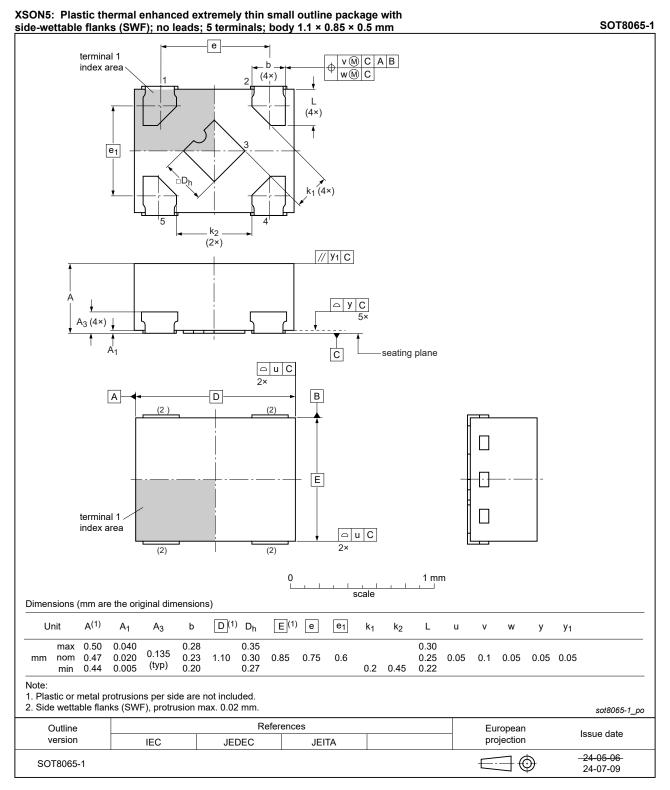


Fig. 10. Package outline SOT8065-1 (XSON5)

Product data sheet

13. Abbreviations

Table 11. Abbreviations

Acronym	Description			
ANSI	American National Standards Institute			
CDM	Charged Device Model			
CMOS	Complementary Metal Oxide Semiconductor			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
ESDA	ElectroStatic Discharge Association			
НВМ	Human Body Model			
JEDEC	Joint Electron Device Engineering Council			
TTL	ransistor-Transistor Logic			

14. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74LVC1G125_Q100 v.7	20240711	Product data sheet	-	74LVC1G125_Q100 v.6	
Modifications:	Type number 74LVC1G125GZ-Q100 (SOT8065-1/XSON5) added.				
74LVC1G125_Q100 v.6	20230823	Product data sheet	-	74LVC1G125_Q100 v.5	
Modifications:	<u>Section 2</u> : ESD specification updated according to the latest JEDEC standard.				
74LVC1G125_Q100 v.5	20220119	Product data sheet	-	74LVC1G125_Q100 v.4	
Modifications:	Fig. 7: Package outline drawing SOT353-1 (TSSOP5) has changed.				
74LVC1G125_Q100 v.4	20211007	Product data sheet	-	74LVC1G125_Q100 v.3	
Modifications:	 <u>Section 1</u> and <u>Section 2</u> updated. <u>Table 5</u>: Derating values for P_{tot} total power dissipation updated. 				
74LVC1G125_Q100 v.3	20190125	Product data sheet	-	74LVC1G125_Q100 v.2	
Modifications:	 The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. Type number 74LVC1G125GM-Q100 (SOT886) added. 				
74LVC1G125_Q100 v.2	20161208	Product data sheet	-	74LVC1G125_Q100 v.1	
Modifications:	• <u>Table 7</u> : The maximum limits for leakage current and supply current have changed.				
74LVC1G125_Q100 v.1	20120709	Product data sheet	-	-	

Product data sheet

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- 2] The term 'short data sheet' is explained in section "Definitions".
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Product data sheet

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